

IVSM12040HA2Z – 1200V 40mΩ Gen2 Automotive SiC MODULE

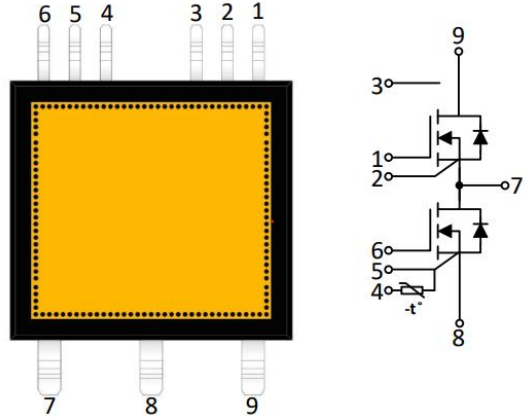
Features

- 2nd Generation SiC MOSFET Technology with +18V gate drive
- High blocking voltage with low on-resistance
- High speed switching with low capacitance
- High operating junction temperature capability
- Very fast and robust intrinsic body diode
- Kelvin gate input easing driver circuit design
- Integrated NTC temperature sensing



Applications

- Automotive OBC and DC/DC converters
- Automotive compressor inverters
- EV chargers
- Switch mode power supplies
- UPS and energy storage systems

Outline:



Marking Diagram:

| | |
|---|---|
| IVSM12040HA2Z | Specific Device Code |
| XXXXX-XXXXX | Wafer Date Code |
|  | IVCT logo |
| YYMMDDNNNP | Lot No. include: YY(year) MM(month) DD(day) NNNN(serial No.) P(mass) |
|  | 2D Code (top side and bottom side): Device Code+ Lot No. |

Absolute Maximum Ratings (Per leg/ $T_c=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Value | Unit | Test Conditions | Note |
|----------------------------|--------------------------------|------------|------------------|--|------------|
| V_{DS} | Drain-Source voltage | 1200 | V | $V_{GS}=0V, I_D=100\mu A$ | |
| V_{GSmax} (Transient) | Maximum transient voltage | -10 to 23 | V | Duty cycle<1%, and pulse width<200ns | |
| V_{GSon} | Recommended turn-on voltage | 15 to 18 | V | | |
| V_{GSoff} | Recommended turn-off voltage | -5 to -2 | V | Typical -3.5V | |
| I_D | Drain current (continuous) | 54 | A | $V_{GS}=18V, T_c=25^\circ\text{C}$ | Fig.23 |
| | | 38 | A | $V_{GS}=18V, T_c=100^\circ\text{C}$ | |
| I_{DM} | Drain current (pulsed) | 135 | A | Pulse width limited by SOA and dynamic $R_{\theta(j-c)}$ | Fig.25, 26 |
| P_{TOT} | Total power dissipation | 220 | W | $T_c=25^\circ\text{C}$ | Fig.24 |
| T_{stg} | Storage temperature range | -55 to 175 | $^\circ\text{C}$ | | |
| T_j | Operating junction temperature | -55 to 175 | $^\circ\text{C}$ | | |

Thermal Data

| Symbol | Parameter | Value | Unit | Note |
|-------------------|--|-------|------|--------|
| $R_{\theta(j-c)}$ | Thermal Resistance from Junction to Case | 0.679 | °C/W | Fig.25 |

Electrical Characteristics (Per leg/ $T_c=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Value | | | Unit | Test Conditions | Note |
|--------------|-----------------------------------|-------|-------|-----------|------------------|---|-------------|
| | | Min. | Typ. | Max. | | | |
| I_{DSS} | Zero gate voltage drain current | | 5 | 100 | μA | $V_{DS}=1200\text{V}, V_{GS}=0\text{V}$ | |
| I_{GSS} | Gate leakage current | | | ± 100 | nA | $V_{DS}=0\text{V}, V_{GS}=-5\sim 20\text{V}$ | |
| V_{TH} | Gate threshold voltage | 1.8 | 2.8 | 4.5 | V | $V_{GS}=V_{DS}, I_D=9\text{mA}$ | Fig.8,9 |
| | | | 2.1 | | V | $V_{GS}=V_{DS}, I_D=9\text{mA}$ @ $T_J=175^\circ\text{C}$ | |
| R_{ON} | Static drain-source on-resistance | | 40 | 52 | $\text{m}\Omega$ | $V_{GS}=18\text{V}, I_D=20\text{A}$ @ $T_J=25^\circ\text{C}$ | Fig.4,5,6,7 |
| | | | 75 | | $\text{m}\Omega$ | $V_{GS}=18\text{V}, I_D=20\text{A}$ @ $T_J=175^\circ\text{C}$ | |
| | | | 50 | 65 | $\text{m}\Omega$ | $V_{GS}=15\text{V}, I_D=20\text{A}$ @ $T_J=25^\circ\text{C}$ | |
| | | | 80 | | $\text{m}\Omega$ | $V_{GS}=15\text{V}, I_D=20\text{A}$ @ $T_J=175^\circ\text{C}$ | |
| C_{iss} | Input capacitance | | 2200 | | pF | $V_{DS}=800\text{V}, V_{GS}=0\text{V},$ $f=100\text{kHz},$ $V_{AC}=25\text{mV}$ | Fig.16 |
| C_{oss} | Output capacitance | | 115 | | pF | | |
| C_{rss} | Reverse transfer capacitance | | 10.2 | | pF | | |
| E_{oss} | C_{oss} stored energy | | 49.4 | | μJ | | Fig.17 |
| Q_g | Total gate charge | | 110 | | nC | $V_{DS}=800\text{V}, I_D=30\text{A},$ $V_{GS}=-3\text{ to }18\text{V}$ | Fig.18 |
| Q_{gs} | Gate-source charge | | 25 | | nC | | |
| Q_{gd} | Gate-drain charge | | 59 | | nC | | |
| R_g | Gate input resistance | | 2.7 | | Ω | $f=1\text{MHz}$ | |
| E_{ON} | Turn-on switching energy | | 461.8 | | μJ | $V_{DS}=800\text{V}, I_D=30\text{A},$ $V_{GS}=-3\text{ to }18\text{V},$ $R_{G(ext)}=3.3\Omega,$ $L=200\mu\text{H}$ $T_J=25^\circ\text{C}$ | Fig.19,20 |
| E_{OFF} | Turn-off switching energy | | 92.32 | | μJ | | |
| $t_{d(on)}$ | Turn-on delay time | | 12.18 | | ns | | |
| t_r | Rise time | | 20.31 | | | | |
| $t_{d(off)}$ | Turn-off delay time | | 22.96 | | | | |
| t_f | Fall time | | 10.85 | | | | |
| E_{ON} | Turn-on switching energy | | 605.2 | | μJ | $V_{DS}=800\text{V}, I_D=30\text{A},$ $V_{GS}=-3\text{ to }18\text{V},$ $R_{G(ext)}=3.3\Omega, L=200\mu\text{H}$ $T_J=175^\circ\text{C}$ | Fig.22 |
| E_{OFF} | Turn-off switching energy | | 93.7 | | μJ | | |

Reverse Diode Characteristics ($T_c=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Value | | | Unit | Test Conditions | Note |
|-----------|-------------------------------|-------|--------|------|------|---|--------------|
| | | Min. | Typ. | Max. | | | |
| V_{SD} | Diode forward voltage | | 4.2 | | V | $I_{SD}=20\text{A}, V_{GS}=0\text{V}$ | Fig.10,11,12 |
| | | | 4.0 | | V | $I_{SD}=20\text{A}, V_{GS}=0\text{V}, T_J=175^\circ\text{C}$ | |
| t_{rr} | Reverse recovery time | | 49.6 | | ns | $V_{GS}=-3\text{V}/+18\text{V},$ | |
| Q_{rr} | Reverse recovery charge | | 371.15 | | nC | $I_{SD}=30\text{A}, V_R=800\text{V},$ | |
| I_{RRM} | Peak reverse recovery current | | 17.96 | | A | $R_{G(ext)}=12.5\Omega, L=200\mu\text{H}$ $di/dt=3050\text{A}/\mu\text{s}$ | |

NTC Thermistor Characteristics

| Symbol | Parameter | Value | | | Unit | Test Conditions | Note |
|--------------|------------------------|-------|------|------|------------|---|------|
| | | Min. | Typ. | Max. | | | |
| R_{25} | Rated Resistance | | 10 | | k Ω | $T_{NTC}=25^\circ\text{C}$ | |
| $\Delta R/R$ | Deviation of R_{100} | -1 | | 1 | % | | |
| $B_{25/85}$ | B-Value | | 3610 | | | $R_2=R_{25}\exp[B_{25/85}(1/T_2-1/(298.15\text{K}))]$ | |
| P_{25} | Power Dissipation | | | 60 | mW | $T_a=25\pm 0.5^\circ\text{C}$ | |

Typical Performance (curves)

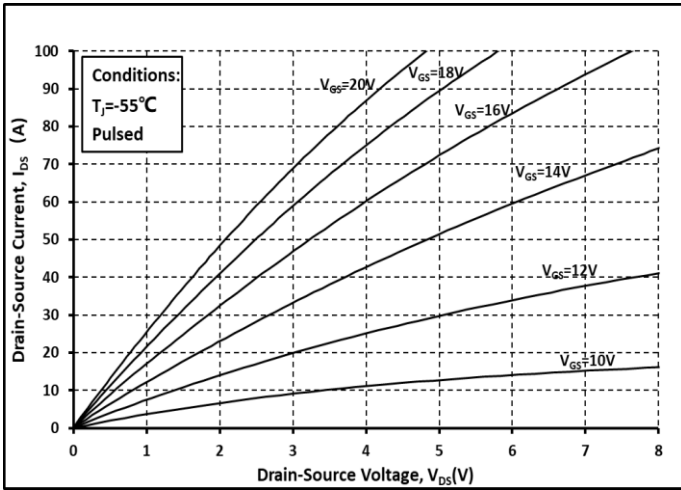


Fig. 1 Output Curve @ $T_j = -55^\circ\text{C}$

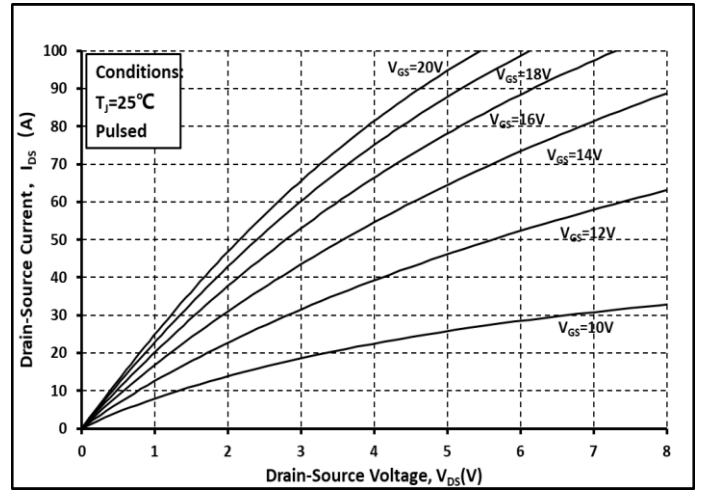


Fig. 2 Output Curve @ $T_j = 25^\circ\text{C}$

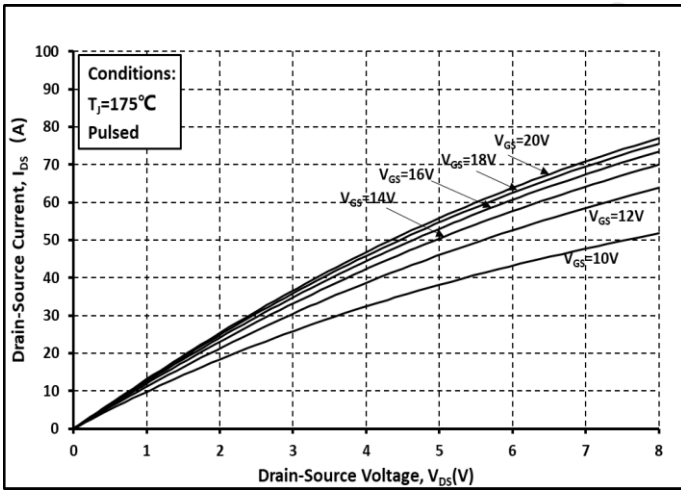


Fig. 3 Output Curve @ $T_j = 175^\circ\text{C}$

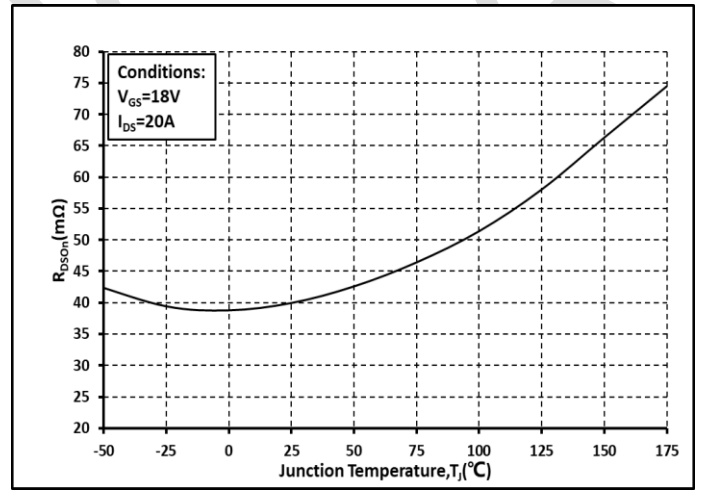


Fig. 4 R_{on} vs. Temperature

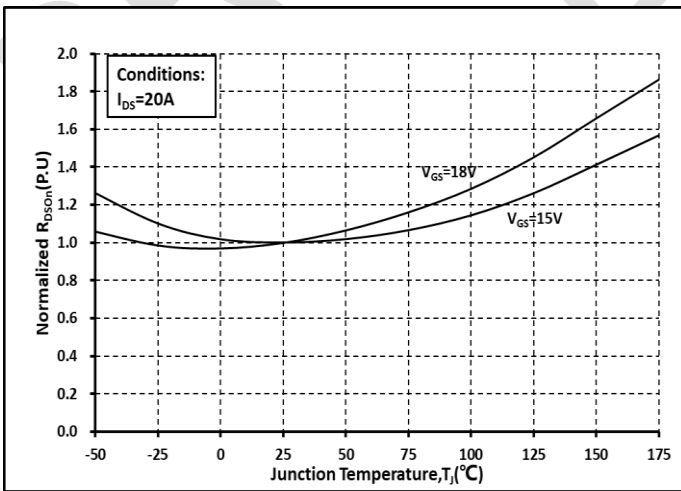


Fig. 5 Normalized R_{on} vs. Temperature

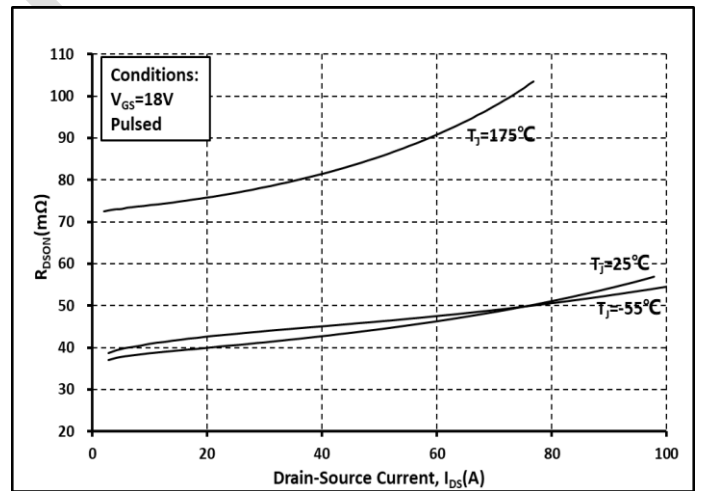


Fig. 6 R_{on} vs. I_{DS} @ Various Temperature

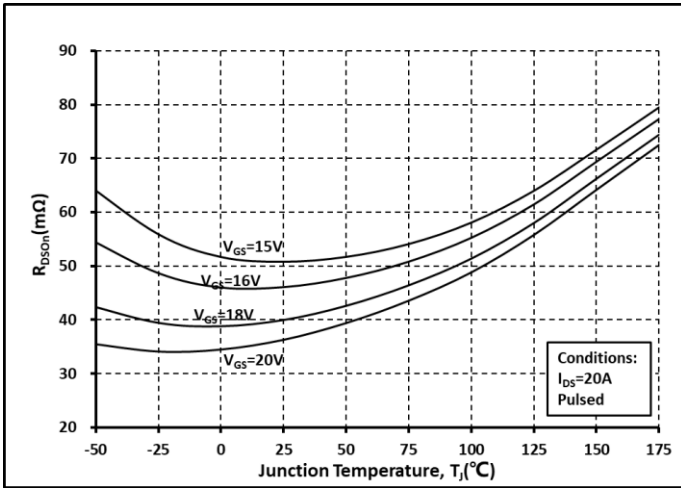


Fig. 7 Ron vs. Temperature @ Various V_{GS}

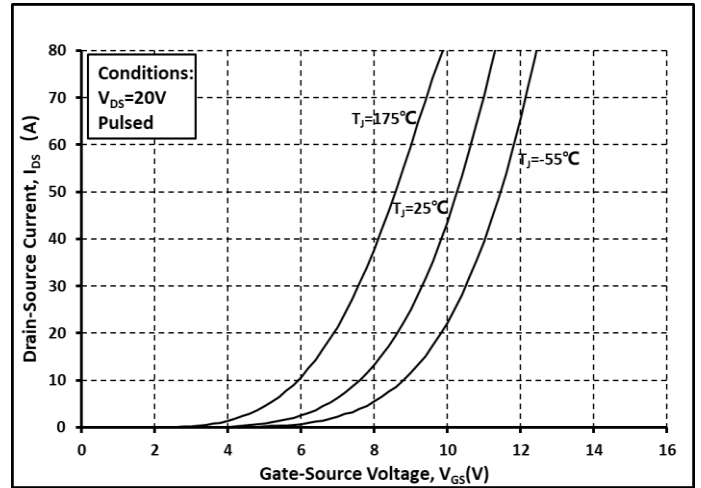


Fig. 8 Transfer Curves @ Various Temperature

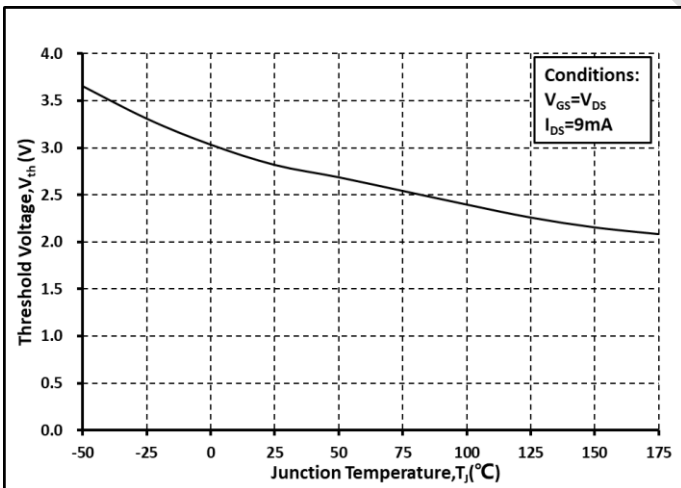


Fig. 9 Threshold Voltage vs. Temperature

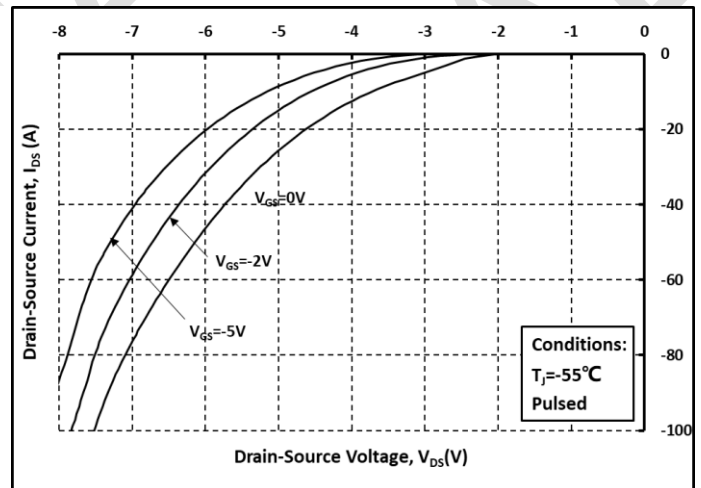


Fig. 10 Body Diode curves @ $T_j = -55^\circ\text{C}$

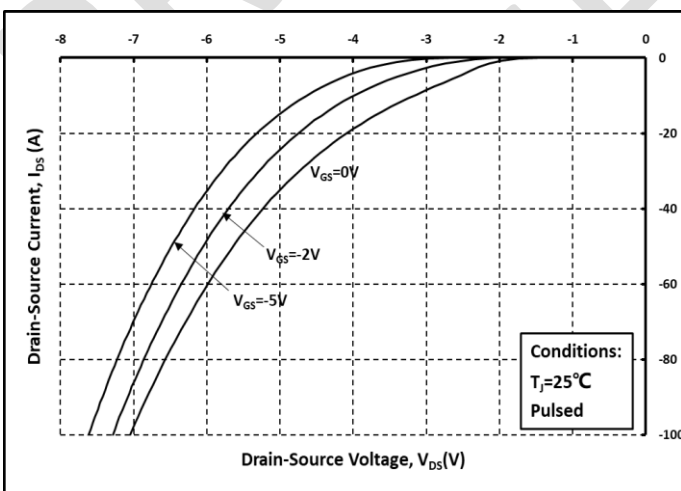


Fig. 11 Body Diode curves @ $T_j = 25^\circ\text{C}$

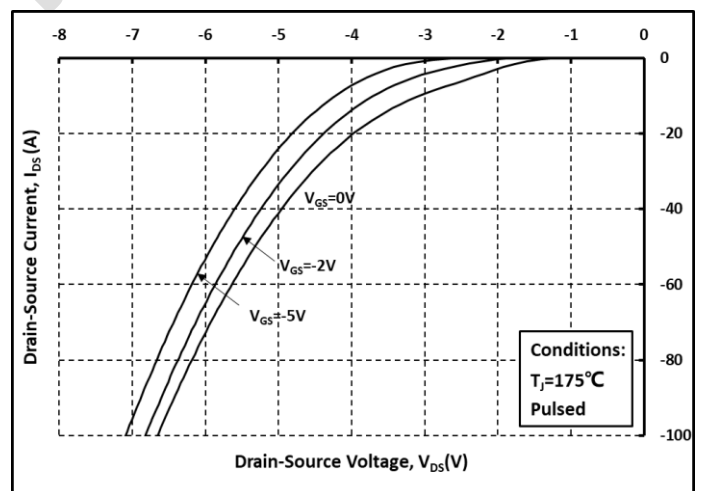


Fig. 12 Body Diode curves @ $T_j = 175^\circ\text{C}$

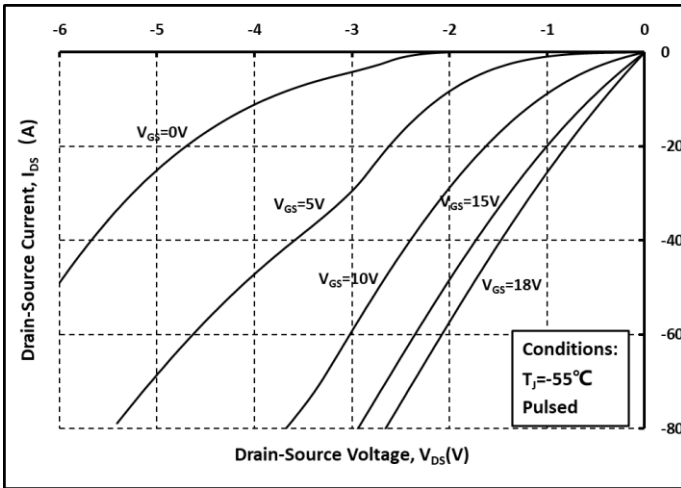


Fig. 13 3rd Quadrant curves @ $T_j = -55^\circ\text{C}$

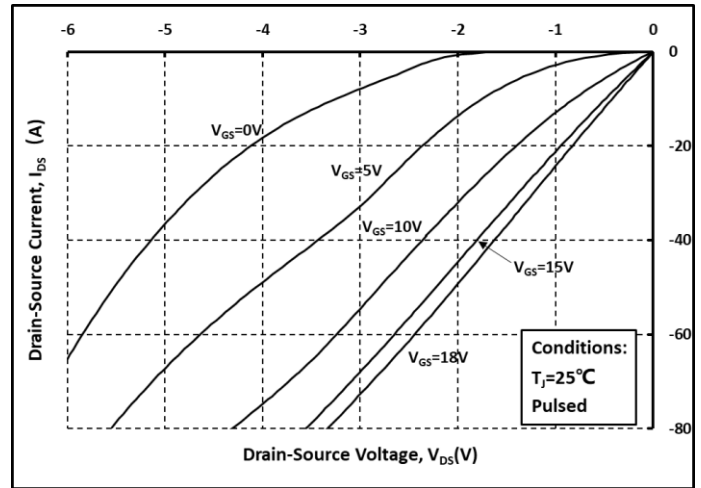


Fig. 14 3rd Quadrant curves @ $T_j = 25^\circ\text{C}$

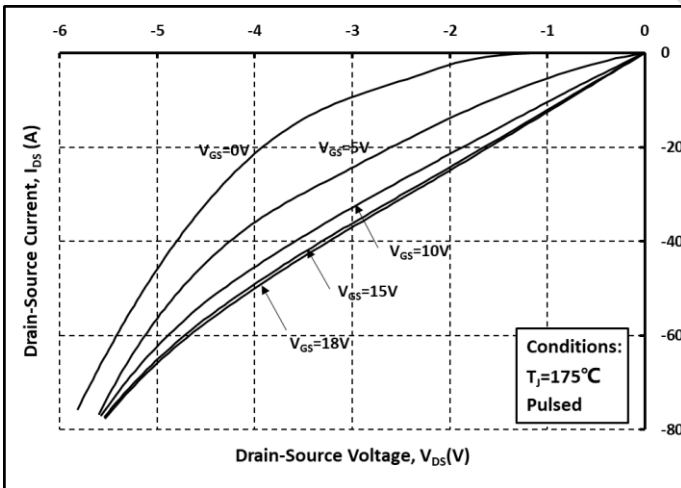


Fig. 15 3rd Quadrant curves @ $T_j = 175^\circ\text{C}$

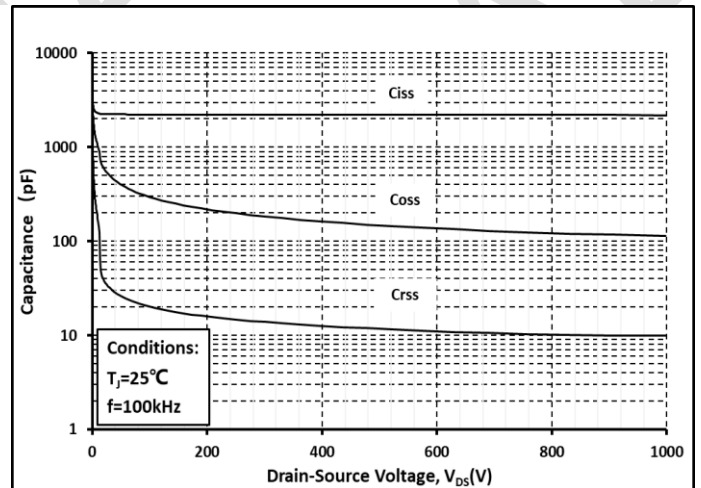


Fig. 16 Capacitance vs. V_{DS}

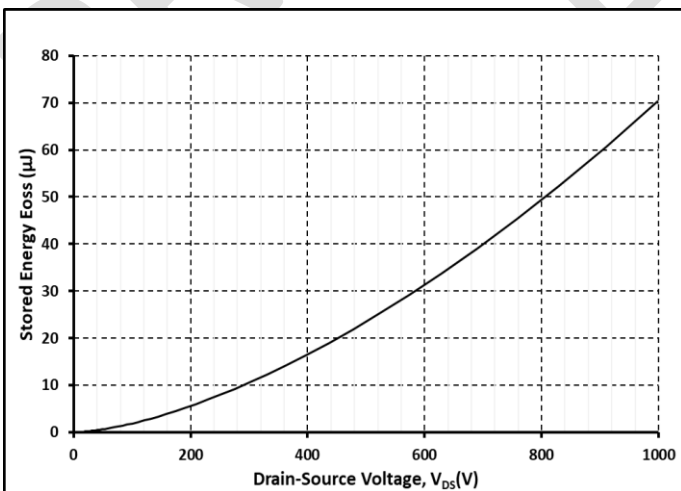


Fig. 17 Output Capacitor Stored Energy

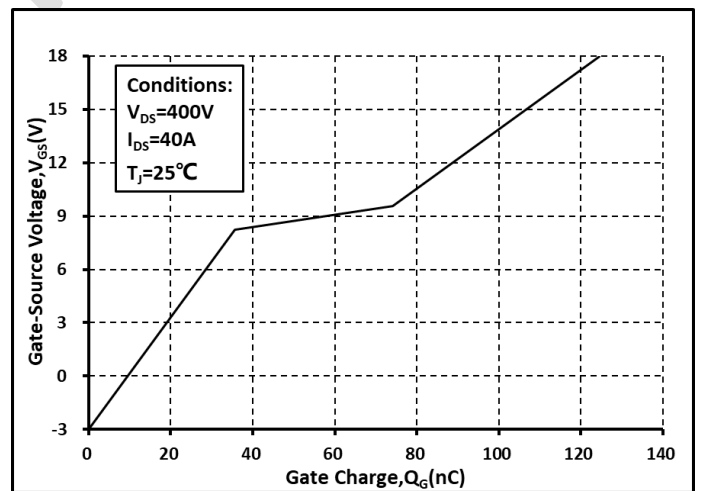


Fig. 18 Gate Charge Characteristics

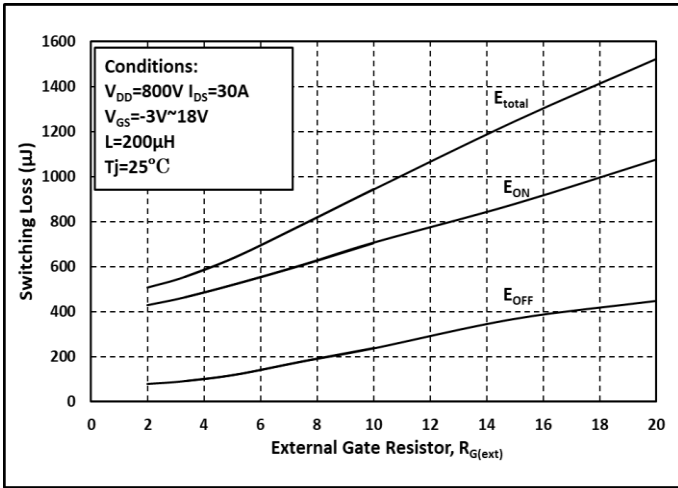


Fig. 19 Switching Energy vs. $R_{G(ext)}$

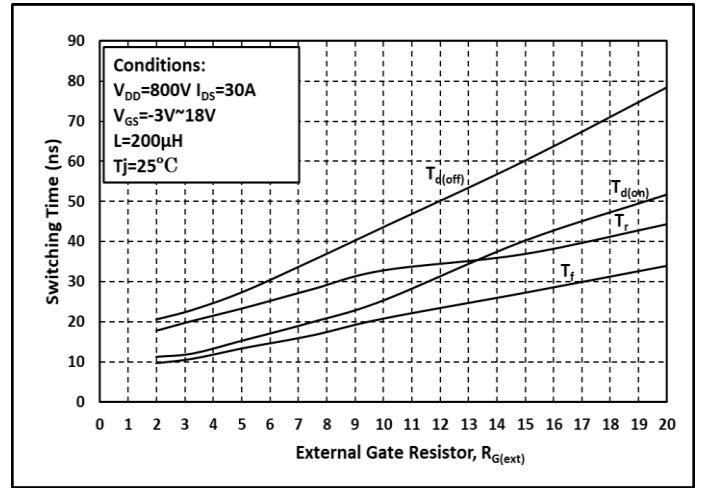


Fig. 20 Switching Times vs. $R_{G(ext)}$

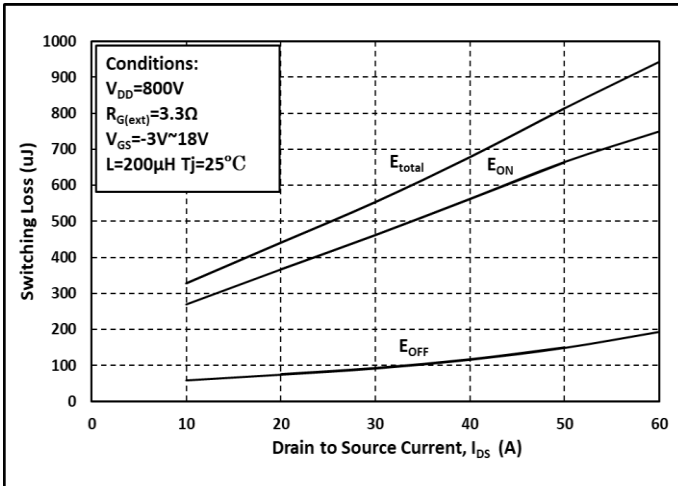


Fig. 21 Switching Energy vs. I_{DS}

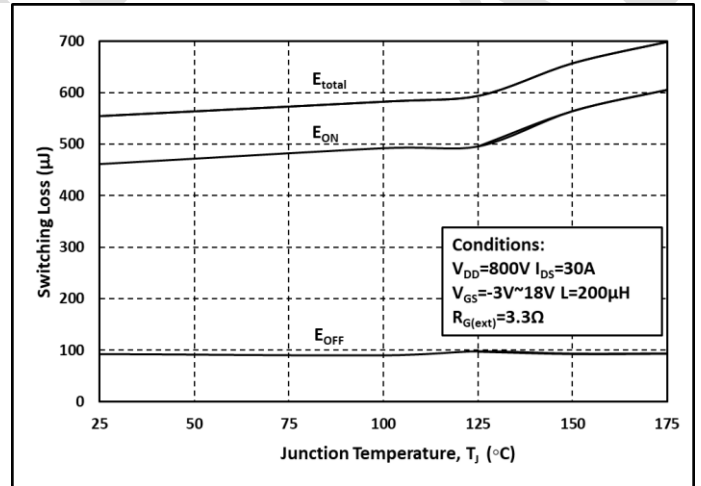


Fig. 22 Switching Energy vs. Temperature

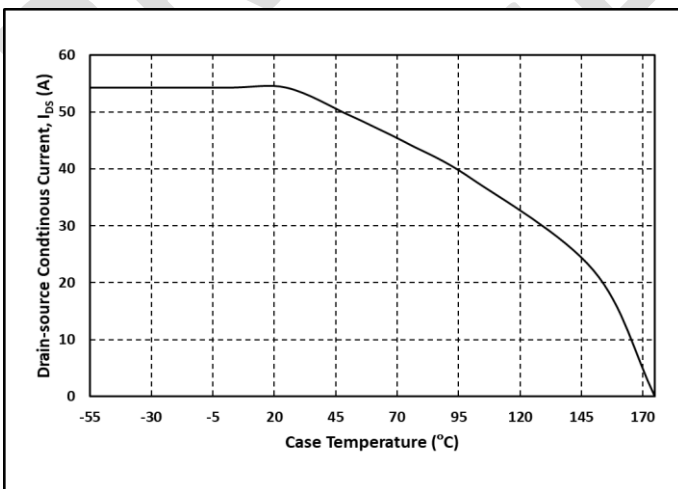


Fig. 23 Continuous Drain Current vs. Case Temperature

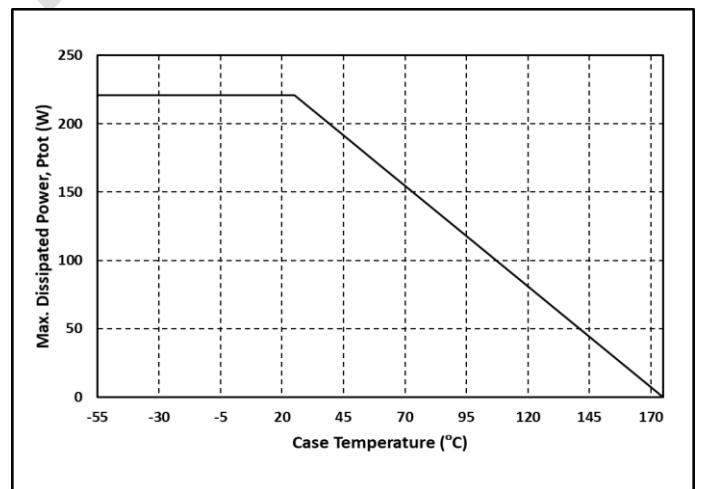


Fig. 24 Max. Power Dissipation Derating vs. Case Temperature

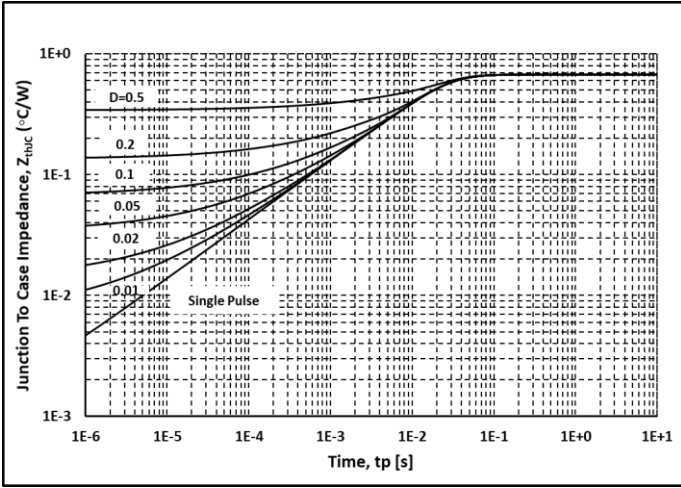


Fig. 25 Thermal impedance

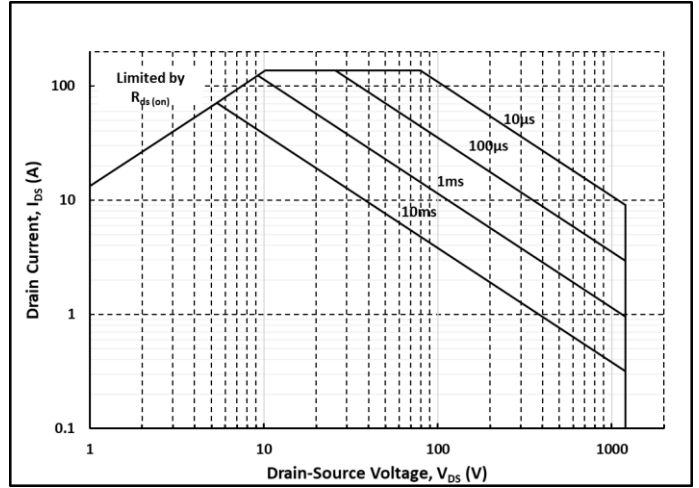
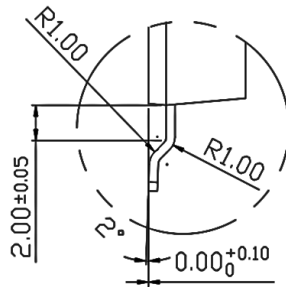
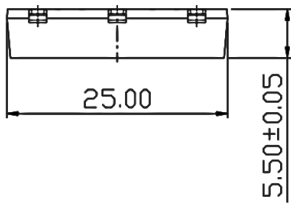
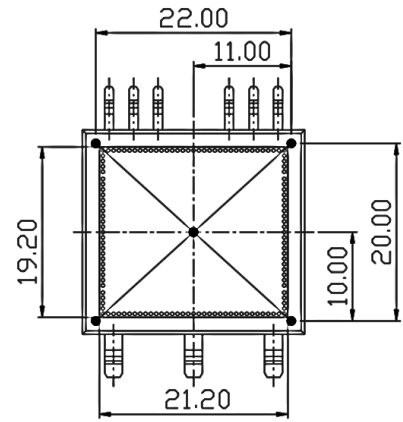
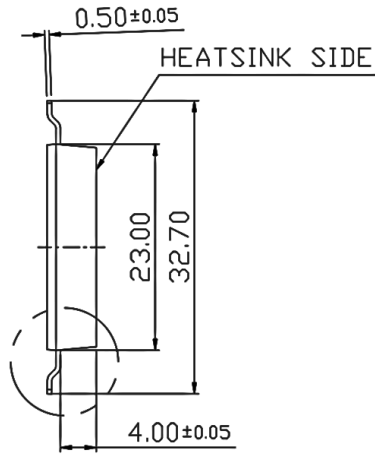
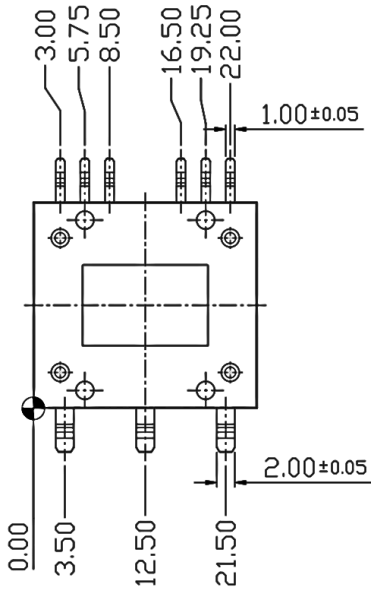


Fig. 26 Safe Operating Area

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Package Dimensions (mm)

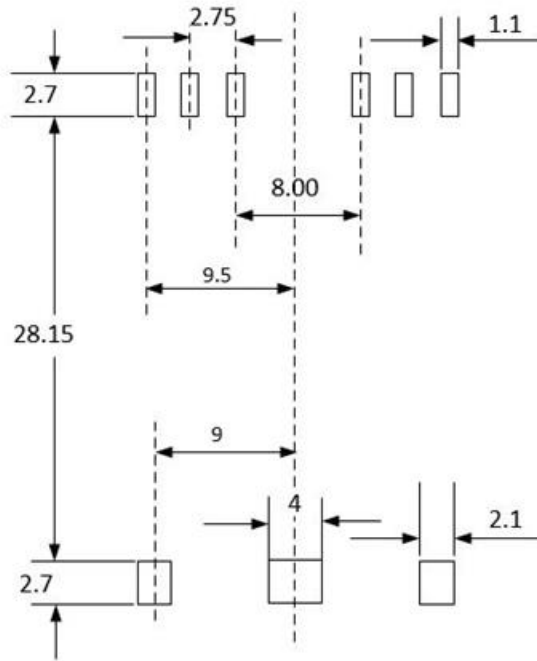


DETAIL A
SCALE 2:1

Note

- 1.General Tolerance ± 0.2 , $\pm 0.5^\circ$
- 2.General $C0.2 \times 45^\circ$ R0.5
- 3.Module Flatness Spec: 0-50um

Recommended footprint (mm)



NOTE:

8pin pad is enlarged to accommodate different packages.

Notes

For further information please contact IVCT's office.

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